# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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### **Complementary Plastic** Silicon Power Transistors

These devices are designed for lower power audio amplifier and low current, high–speed switching applications.

#### Features

- Low Collector-Emitter Sustaining Voltage
- High Current–Gain Bandwidth Product
- These Devices are Pb-Free and are RoHS Compliant\*

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	60	Vdc
Collector-Base Voltage	V <sub>CBO</sub>	80	Vdc
Emitter Base Voltage	V <sub>EBO</sub>	6.0	Vdc
Collector Current – Continuous	Ι <sub>C</sub>	4.0	Adc
Collector Current – Peak	I <sub>CM</sub>	8.0	Adc
Base Current – Continuous	Ι <sub>Β</sub>	1.0	Adc
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	15 0.12	W mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

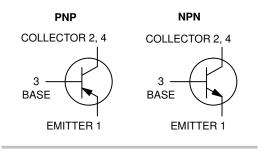
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	8.34	°C/W



#### **ON Semiconductor®**

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#### 4 AMPERES POWER TRANSISTORS COMPLEMENTARY SILICON 60 VOLTS, 15 WATTS





#### MARKING DIAGRAM



 $\begin{array}{lll} Y &= Year \\ WW &= Work Week \\ BD78x &= Device Code \\ & x = 7 \ or \ 8 \\ G &= Pb-Free \ Package \end{array}$ 

#### **ORDERING INFORMATION**

Device	Package	Shipping
BD787G	TO–225 (Pb–Free)	500 Units/Box
BD788G	TO-225 (Pb-Free)	500 Units/Box

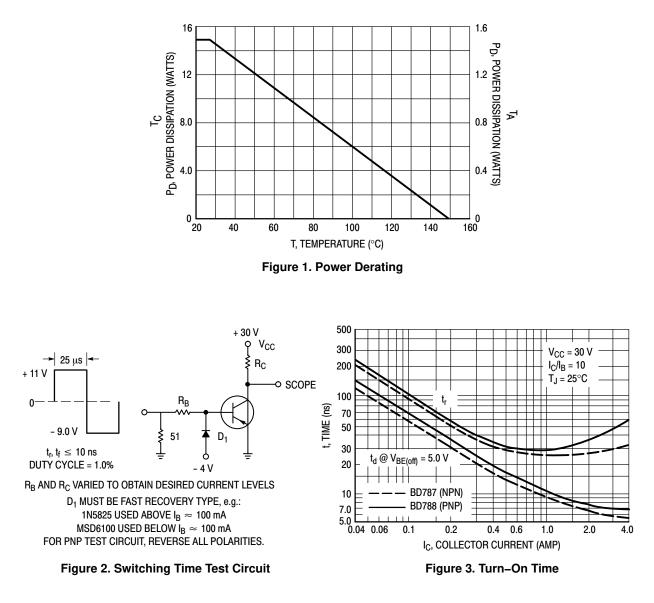
\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

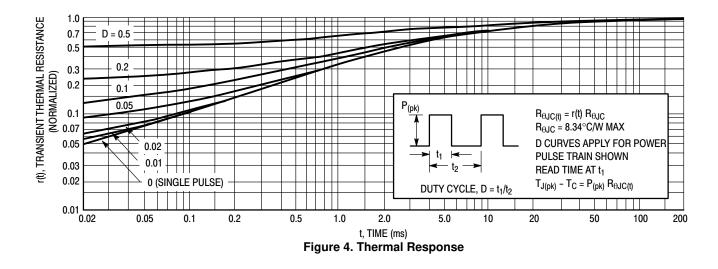
#### **ELECTRICAL CHARACTERISTICS\*** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Sustaining Voltage (Note 1) $(I_{C} = 10 \text{ mAdc}, I_{B} = 0)$	V <sub>CEO(sus)</sub>	60	-	Vdc
	ICEO	-	100	μAdc
$      Collector Cutoff Current \\ (V_{CE} = 80 Vdc, V_{BE(off)} = 1.5 Vdc) \\ (V_{CE} = 40 Vdc, V_{BE(off)} = 1.5 Vdc, T_C = 125^{\circ}C) $	ICEX		1.0 0.1	μAdc mAdc
Emitter Cutoff Current ( $V_{EB} = 6.0 \text{ Vdc}, I_C = 0$ )	I <sub>EBO</sub>	_	1.0	μAdc
ON CHARACTERISTICS (Note 1)				
$\begin{array}{l} \text{DC Current Gain} \\ (I_{C} = 200 \text{ mAdc}, V_{CE} = 3.0 \text{ Vdc}) \\ (I_{C} = 1.0 \text{ Adc}, V_{CE} = 3.0 \text{ Vdc}) \\ (I_{C} = 2.0 \text{ Adc}, V_{CE} = 3.0 \text{ Vdc}) \\ (I_{C} = 4.0 \text{ Adc}, V_{CE} = 3.0 \text{ Vdc}) \end{array}$	h <sub>FE</sub>	40 25 20 5.0	250 _ _ _	-
	V <sub>CE(sat)</sub>		0.4 0.6 0.8 2.5	Vdc
Base-Emitter Saturation Voltage $(I_C = 2.0 \text{ Adc}, I_B = 200 \text{ mAdc})$	V <sub>BE(sat)</sub>	_	2.0	Vdc
Base–Emitter On Voltage (I <sub>C</sub> = 2.0 Adc, V <sub>CE</sub> = 3.0 Vdc)	V <sub>BE(on)</sub>	_	1.8	Vdc
DYNAMIC CHARACTERISTICS				•
Current–Gain – Bandwidth Product (I <sub>C</sub> = 100 mAdc, V <sub>CE</sub> = 10 Vdc, f = 10 MHz)	f <sub>T</sub>	50	_	MHz
Output Capacitance	<u> </u>			ъĘ

(I <sub>C</sub> = 100 mAdc, V <sub>CE</sub> = 10 Vdc, f = 10 MHz)		50	-	
Output Capacitance $(V_{CB} = 10 \text{ Vdc}, I_C = 0)$	C <sub>ob</sub>			pF
BD787G (f = 0.1 MHz)		-	50	
(I = 0.1 MHZ) BD788G		-	70	
Small–Signal Current Gain (I <sub>C</sub> = 200 mAdc, V <sub>CE</sub> = 10 Vdc, f = 1.0 kHz)	h <sub>fe</sub>	10	_	-

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. \*Indicates JEDEC Registered Data 1. Pulse Test; Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2.0%.





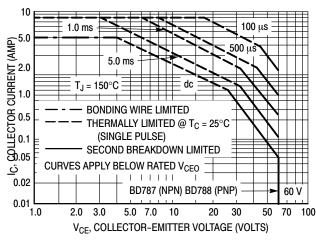
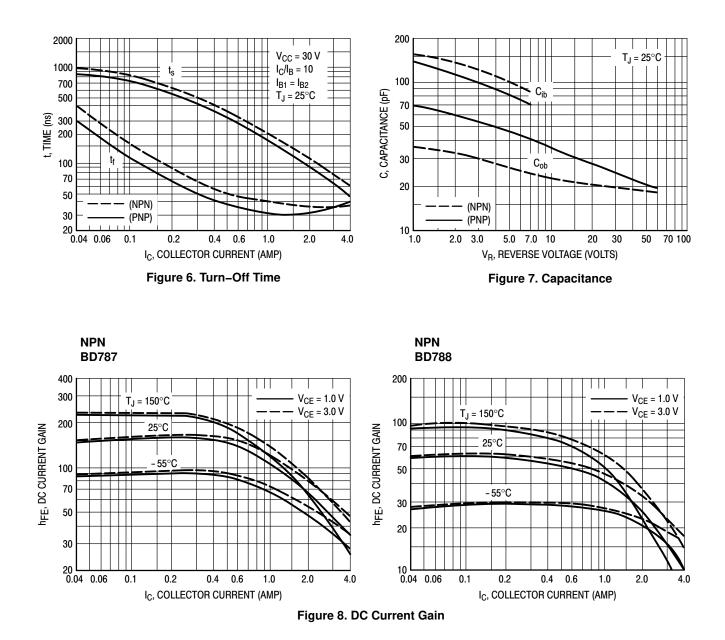


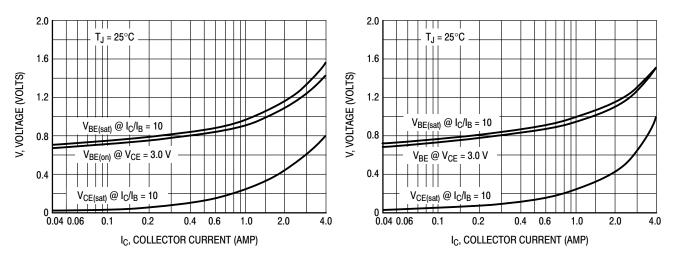
Figure 5. Active Region Safe Operating Area

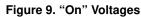
There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation, i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

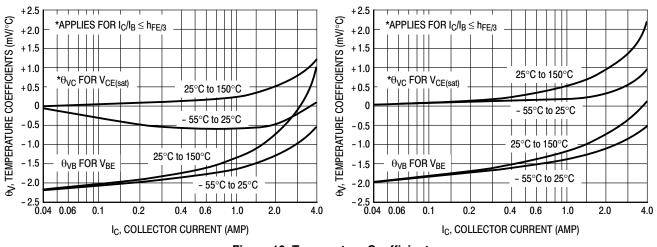
The data of Figure 5 is based on  $T_{J(pk)} = 150^{\circ}C$ :  $T_C$  is variable depending on conditions. Second breakdown pulse limits are valid for duty cycles to 10% provided  $T_{J(pk)} \le 150^{\circ}C$ ,  $T_{J(pk)}$  may be calculated from the data in Figure 4. At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

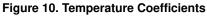


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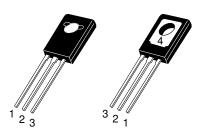








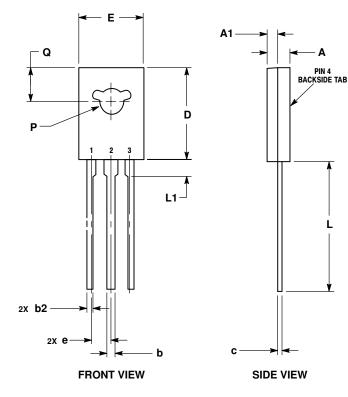
#### PACKAGE DIMENSIONS



TO-225 CASE 77-09 **ISSUE AC** 

FRONT VIEW

**BACK VIEW** 



NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. NUMBER AND SHAPE OF LUGS OPTIONAL.

	MILLIMETERS		
DIM	MIN	MAX	
Α	2.40	3.00	
A1	1.00	1.50	
b	0.60	0.90	
b2	0.51	0.88	
C	0.39	0.63	
D	10.60	11.10	
E	7.40	7.80	
е	2.04	2.54	
L	14.50	16.63	
L1	1.27	2.54	
Р	2.90	3.30	
Q	3.80	4.20	
STYLE 1: PIN 1. EMITTER			
<ol><li>2., 4. COLLECTOR</li></ol>			
	3. BASE		

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